

72R Series



Description

The 72R Series is designed to provide overcurrent protection to 72Vdc maximum voltage with a maximum 40A short circuit rating.

Features

- 72Vdc max voltage w/max 40A short circuit rating
- RoHS compliant, Lead-Free and Halogen Free*
- Resettable feature
- Ideal for a broad range of general electronics using a low voltage power supply

Applications

- Load protection on wide range of low voltage power supplies
- Computers
- Computer peripherals
- General electronics

Agency Approvals

AGENCY	AGENCY FILE NUMBER
	E183209
	R50119318

Electrical Characteristics

Part Number	I _{hold} (A)	I _{trip} (A)	V _{max} (Vdc)	I _{max} (A)	P _d typ. (W)	Maximum Time To Trip		Resistance		Agency Approvals	
						Current (A)	Time (Sec.)	R _{min} (Ω)	R _{1max} (Ω)		
72R020X	0.20	0.40	72	40	0.41	1.00	2.20	1.830	4.400	X	X
72R025X	0.25	0.50	72	40	0.45	1.25	2.50	1.250	3.000	X	X
72R030X	0.30	0.60	72	40	0.49	1.50	3.00	0.880	2.100	X	X
72R040X	0.40	0.80	72	40	0.56	2.00	3.80	0.550	1.290	X	X
72R050X	0.50	1.00	72	40	0.77	2.50	4.00	0.500	1.170	X	X
72R065X	0.65	1.30	72	40	0.88	3.25	5.30	0.310	0.720	X	X
72R075X	0.75	1.50	72	40	0.92	3.75	6.30	0.250	0.600	X	X
72R090X	0.90	1.80	72	40	0.99	4.50	7.20	0.200	0.470	X	X
72R110X	1.10	2.20	72	40	1.50	5.50	8.20	0.150	0.380	X	X
72R135X	1.35	2.70	72	40	1.70	6.75	9.60	0.120	0.300	X	X
72R160X	1.60	3.20	72	40	1.90	8.00	11.40	0.090	0.220	X	X
72R185X	1.85	3.70	72	40	2.10	9.25	12.60	0.080	0.190	X	X
72R250X	2.50	5.00	72	40	2.50	12.50	15.60	0.050	0.130	X	X
72R300X	3.00	6.00	72	40	2.80	15.00	19.80	0.040	0.100	X	X
72R375X	3.75	7.50	72	40	3.20	18.75	24.00	0.030	0.080	X	X

I_{hold} = Hold current: maximum current device will pass without tripping in 20°C still air.

I_{trip} = Trip current: minimum current at which the device will trip in 20°C still air.

V_{max} = Maximum voltage device can withstand without damage at rated current (I_{max})

I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})

P_d = Power dissipated from device when in the tripped state at 20°C still air.

R_{min} = Minimum resistance of device in initial (un-soldered) state.

R_{1max} = Maximum resistance of device at 20°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

* Effective January 1, 2010, all 72R PTC products will be manufactured Halogen Free (HF). Existing Non-Halogen Free 72R PTC products may continue to be sold, until supplies are depleted.

Temperature Derating

Part Number	Ambient Operation Temperature								
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C
	Hold Current (A)								
72R020X	0.31	0.27	0.24	0.20	0.16	0.14	0.13	0.11	0.08
72R025X	0.39	0.34	0.30	0.25	0.20	0.18	0.16	0.14	0.10
72R030X	0.47	0.41	0.36	0.30	0.24	0.22	0.19	0.16	0.12
72R040X	0.62	0.54	0.48	0.40	0.32	0.29	0.25	0.22	0.16
72R050X	0.78	0.68	0.60	0.50	0.41	0.36	0.32	0.27	0.20
72R065X	1.01	0.88	0.77	0.65	0.53	0.47	0.41	0.35	0.26
72R075X	1.16	1.02	0.89	0.75	0.61	0.54	0.47	0.41	0.30
72R090X	1.40	1.22	1.07	0.90	0.73	0.65	0.57	0.49	0.36
72R110X	1.71	1.50	1.31	1.10	0.89	0.79	0.69	0.59	0.44
72R135X	2.09	1.84	1.61	1.35	1.09	0.97	0.85	0.73	0.54
72R160X	2.48	2.18	1.90	1.60	1.30	1.15	1.01	0.86	0.64
72R185X	2.87	2.52	2.20	1.85	1.50	1.33	1.17	1.00	0.74
72R250X	3.88	3.40	2.98	2.50	2.03	1.80	1.58	1.35	1.00
72R300X	4.65	4.08	3.57	3.00	2.43	2.16	1.89	1.62	1.20
72R375X	5.81	5.10	4.46	3.75	3.04	2.70	2.36	2.03	1.50

Average Time Current Curves



The average time current curves and Temperature Derating curve performance is affected by a number of variables, and these curves provided as guidance only. Customer must verify the performance in their application.

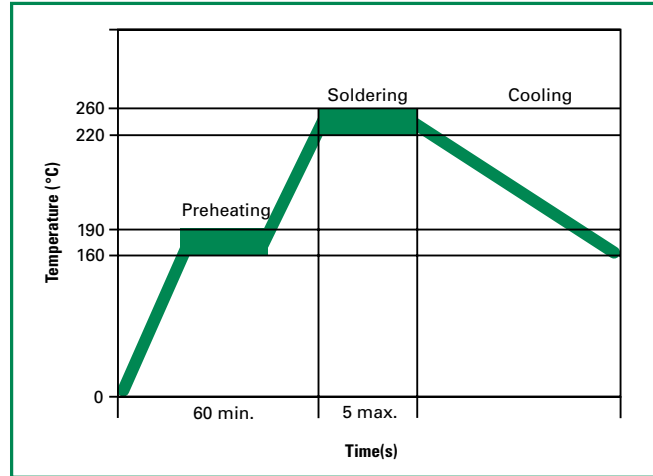
Temperature Derating Curve



Note:
Typical Temperature derating curve, refer to table for derating data

Soldering Parameters - Wave Soldering

Pre-Heating Zone	Refer to the condition recommended by the flux manufacturer. Max. ramping rate should not exceed 4°C/Sec.
Soldering Zone	Max. solder temperature should not exceed 260°C Time within 5°C of actual Max. solder temperature within 3 - 5 seconds Total time from 25°C room to Max. solder temperature within 5 minutes including Pre-Heating time
Cooling Zone	Cooling by natural convection in air. Max. ramping down rate should not exceed 6°C/Sec.



Physical Specifications

Lead Material	0.20-0.40A: Tin-plated Copper clad steel 0.50-3.75A: Tin-plated Copper
Soldering Characteristics	Solderability per MIL-STD-202, Method 208
Insulating Material	Cured, flame retardant epoxy polymer meets UL 94V-0 requirements.
Lead Solderability	Marked with 'LF', voltage, current rating, and date code.

Environmental Specifications

Operating/Storage Temperature	-40°C to +85°C
Maximum Device Surface Temperature in Tripped State	125°C
Passive Aging	+85°C, 1000 hours -/+5% typical resistance change
Humidity Aging	+85°C, 85% R.H. 1000 hours -/+5% typical resistance change
Thermal Shock	+85°C to -40°C 10 times -/+5% typical resistance change
Solvent Resistance	MIL-STD-202, Method 215
Moisture Sensitivity Level	Level 1, J-STD-020

Additional Information



Datasheet

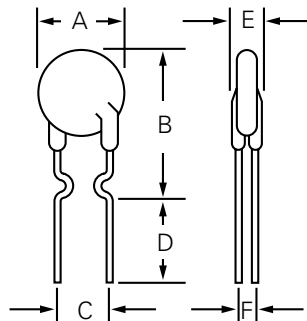


Resources

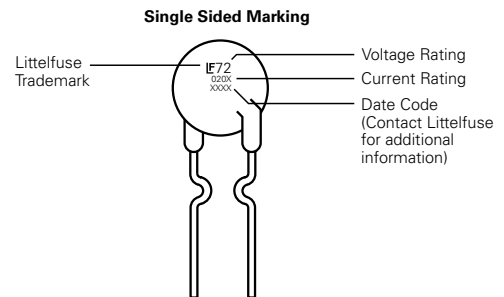


Samples

Dimensions



Part Marking System



Part Number	A		B		C		D		E		F		Physical Characteristics		
	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Lead (dia)		Material
	Max.	Max.	Max.	Max.	Typ.	Typ.	Min.	Min.	Max.	Max.	Typ.	Typ.	Inches	mm	
72R020X	0.29	7.4	0.46	11.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
72R025X	0.29	7.4	0.50	12.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
72R030X	0.29	7.4	0.50	12.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
72R040X	0.30	7.6	0.53	13.5	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
72R050X	0.31	7.9	0.54	13.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
72R065X	0.37	9.4	0.57	14.5	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
72R075X	0.40	10.2	0.60	15.2	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
72R090X	0.44	11.2	0.62	15.8	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
72R110X	0.51	13.0	0.72	18.2	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
72R135X	0.53	13.58	0.78	19.8	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
72R160X	0.60	15.36	0.85	21.6	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
72R185X	0.66	16.76	0.91	23.0	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
72R250X	0.78	19.93	1.03	26.2	0.40	10.2	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
72R300X	0.91	23.11	1.15	29.3	0.40	10.2	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
72R375X	1.04	26.3	1.22	31.1	0.40	10.2	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu

Part Ordering Number System



Packaging

Part Number	Ordering Part Number	I_{hold} (A)	I_{hold} Code	Packaging Option	Quantity	Quantity & Packaging Codes
72R020X	72R020XU	0.20	020	Bulk	500	U
	72R020XPR			Tape and Ammo	2000	PR
72R025X	72R025XU	0.25	025	Bulk	500	U
	72R025XPR			Tape and Ammo	2000	PR
72R030X	72R030XU	0.30	030	Bulk	500	U
	72R030XPR			Tape and Ammo	2000	PR
72R040X	72R040XU	0.40	040	Bulk	500	U
	72R040XPR			Tape and Ammo	2000	PR
72R050X	72R050XU	0.50	050	Bulk	500	U
	72R050XPR			Tape and Ammo	2000	PR
72R065X	72R065XU	0.65	065	Bulk	500	U
	72R065XPR			Tape and Ammo	2000	PR
72R075X	72R075XU	0.75	075	Bulk	500	U
	72R075XPR			Tape and Ammo	2000	PR
72R090X	72R090XU	0.90	090	Bulk	500	U
	72R090XPR			Tape and Ammo	2000	PR
72R110X	72R110XU	1.10	110	Bulk	500	U
	72R110XMR			Tape and Ammo	1000	MR
72R135X	72R135XF	1.35	135	Bulk	200	F
	72R135XMR			Tape and Ammo	1000	MR
72R160X	72R160XF	1.60	160	Bulk	200	F
	72R160XMR			Tape and Ammo	1000	MR
72R185X	72R185XF	1.85	185	Bulk	200	F
	72R185XMR			Tape and Ammo	1000	MR
72R250X	72R250XF	2.50	250	Bulk	200	F
	72R250XMR			Tape and Ammo	1000	MR
72R300X	72R300XF	3.00	300	Bulk	200	F
	72R300XMR			Tape and Ammo	1000	MR
72R375X	72R375XH	3.75	375	Bulk	100	H

Tape and Ammo Specifications

Devices taped using EIA468-B/IE286-2 standards. See table below and Figure 1 for details.

Dimension	EIA Mark	IEC Mark	Dimensions	
			Dim. (mm)	Tol. (mm)
Carrier tape width	W	W	18	-0.5 / +1.0
Hold down tape width	W₄	W₀	11	min.
Top distance between tape edges	W₆	W₂	3	max.
Sprocket hole position	W₅	W₁	9	-0.5 / +0.75
Sprocket hole diameter*	D₀	D₀	4	-0.32 / +0.2
Abscissa to plane (straight lead)	H	H	18.5	-/+ 3.0
Abscissa to plane (kinked lead)	H₀	H₀	16	-/+ 0.5
Abscissa to top 72R020X-72R090X	H₁	H₁	32.2	max.
Abscissa to top 72R110X-72R300X	H₁		47.5	max.
Overall width without lead protrusion: 72R020X-72R090X	C₁		42.5	max.
Overall width without lead protrusion: 72R110X-72R300X			57	
Overall width with lead protrusion: 72R020X-72R090X	C₂		43.2	max.
Overall width with lead protrusion: 72R110X-72R300X		58		
Lead protrusion	L₁	I₁	1.0	max.
Protrusion of cut out	L	L	11	max.
Protrusion beyond hold-down tape	I₂	I₂	Not specified	
Sprocket hole pitch: 72R020X-72R090X	P₀	P₀	12.7	-/+ 0.3
Sprocket hole pitch: 72R110X-72R300X	P₀	P₀	25.4	-/+ 0.5
Pitch tolerance			20 consecutive.	-/+ 1
Device pitch: 72R020X-72R090X			12.7	
Device pitch: 72R110X-72R300X			25.4	
Tape thickness	t	t	0.9	max.
Tape thickness with splice	t₁		2.0	max.
Splice sprocket hole alignment			0	-/+ 0.3
Body lateral deviation	Δh	Δh	0	-/+ 1.0
Body tape plane deviation	Δp	Δp	0	-/+ 1.3
Ordinate to adjacent component lead*: 72R020X-72R090X	P₁	P₁	3.81	-/+ 0.7
Ordinate to adjacent component lead*: 72R110X-72R300X			7.62	-/+ 0.7
Lead spacing: 72R020X-72R185X	F	F	5.08	-/+ 0.8
Lead spacing: 72R250X-72R300X	F	F	10.18	-/+ 0.8

*Differs from EIA Specification

Tape and Ammo Diagram

Figure 1



WARNING

- Users shall independently assess the suitability of these devices for each of their applications
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire
- These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses
- Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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